502078094 09/28/2012

PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Satoshi Matsubara	07/24/2012
Hideyuki Umetsu	07/24/2012
Takayuki Hase	07/24/2012

RECEIVING PARTY DATA

Name:	Toray Industries, Inc.
Street Address:	1-1, Nihonbashi-Muromachi 2-chome
Internal Address:	Chuo-ku
City:	Tokyo
State/Country:	JAPAN
Postal Code:	103-8666

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	13638052

CORRESPONDENCE DATA

2156562498 Fax Number:

Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

215-656-3381 Phone:

Email: pto.phil@dlapiper.com

Correspondent Name: IP GROUP OF DLA PIPER LLP (US)

ONE LIBERTY PLACE Address Line 1:

1650 MARKET ST, SUITE 4900 Address Line 2:

PHILADELPHIA, PENNSYLVANIA 19103 Address Line 4:

ATTORNEY DOCKET NUMBER: MIP-12-1332 (382460-005)

Leslie J. Hood

Total Attachments: 1

NAME OF SUBMITTER:

source=Assignment#page1.tif

502078094

PATENT REEL: 029042 FRAME: 0842

ASSIGNMENT

WHEREAS, we, Satoshi MATSUBARA, Hideyuki UMETSU and Takayuki HASE, citizens of Japan, residing at Nagoya-shi, Aichi, Japan, (hereinafter referred to as "the undersigned"), having made an invention entitled LIQUID CRYSTALLINE POLYESTER COMPOSITION AND METAL COMPOSITE MOLDED PRODUCT USING THE SAME, identified in International Application No. PCT/JP2011/006990, and US Application No. 13/638,052 , (DLA Piper is authorized to insert the Serial No. when known),

WHEREAS, <u>TORAY INDUSTRIES</u>, <u>INC.</u>, with offices at <u>1-1</u>, <u>Nihonbashi-Muromachi</u> <u>2-chome</u>, <u>Chuo-ku</u>, <u>Tokyo</u>, <u>103-8666 Japan</u> (hereinafter referred to as "assignee"), is desirous of acquiring the entire right, title and interest in said invention, said US application and all letters patent issuing for said invention,

NOW, THEREFORE, in consideration of One Dollar (\$1.00) and of other good and valuable consideration, receipt of which is hereby acknowledged, the undersigned, intending to be legally bound, does hereby sell, assign and transfer to the assignee the entire right, title and interest, for the United States of America, its territories and possessions, and for all foreign countries, in said invention, including said US application, all divisions and continuations thereof, all rights to claim priority based thereon, all rights to file foreign applications on said invention, and all letters patent and reissues thereof, issuing for said invention in the United States of America and in any and all foreign countries.

It is agreed that the undersigned shall be legally bound, upon request of the assignee, or its successors or assigns or a legal representative thereof, to supply all information and evidence of which the undersigned has knowledge or possession, relating to the making and practice of said invention, to testify in any legal proceeding relating thereto, to execute all instruments proper to patent the invention in the United States of America and foreign countries in the name of the assignee, and to execute all instruments proper to carry out the intent of this instrument. If the undersigned includes more than one individual, these obligations shall apply to all of the undersigned both individually and collectively.

The rights and property herein conveyed by the undersigned are free and clear of any encumbrance.

EXECUTED on the date(s) set forth below.	
July 24, 2012 Date	Satoshi Matsubura
Date /	Satoshi MATSUBARA
July 24, 2012 Date	<u> Hideyuhi Umeteu</u> Hideyuki UMETSU
	•
July 24, 2012 Date	Takayuki Hase
Date /	Takayuki HAS E
Date	
Date	
Date	
Data	
Date	

PATENT REEL: 029042 FRAME: 0843

RECORDED: 09/28/2012